



LG-355PT2C94F-928 PHOTO TRANSISTOR DATA SHEET

 SPEC. NO.
 : SZ20111604

 DATE
 : 2021/05/21

REV. : <u>A/3</u>

Approved By: Checked By: Prepared By:

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Photo Transistor Diode Specification

●Commodity: Photo Transistor

●Ic(on) Bin Code (V_{CE}=5V, Ee=1mW/cm², p=940nm)

| BIN CODE | Min. (mA) | Max. (mA) |
|----------|-----------|-----------|
| X2 | 3.7 | 4.4 |
| Х3 | 4.4 | 5.3 |

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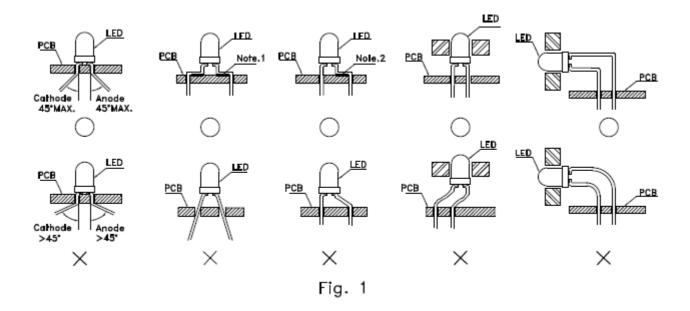






LED MOUNTING METHOD

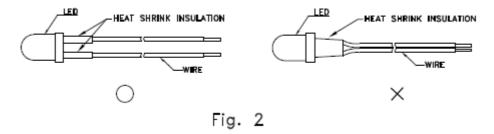
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).



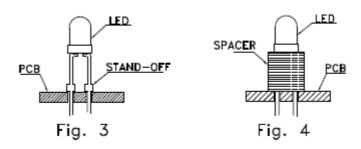
" " Correct mounting method "x" Incorrect mounting method

Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

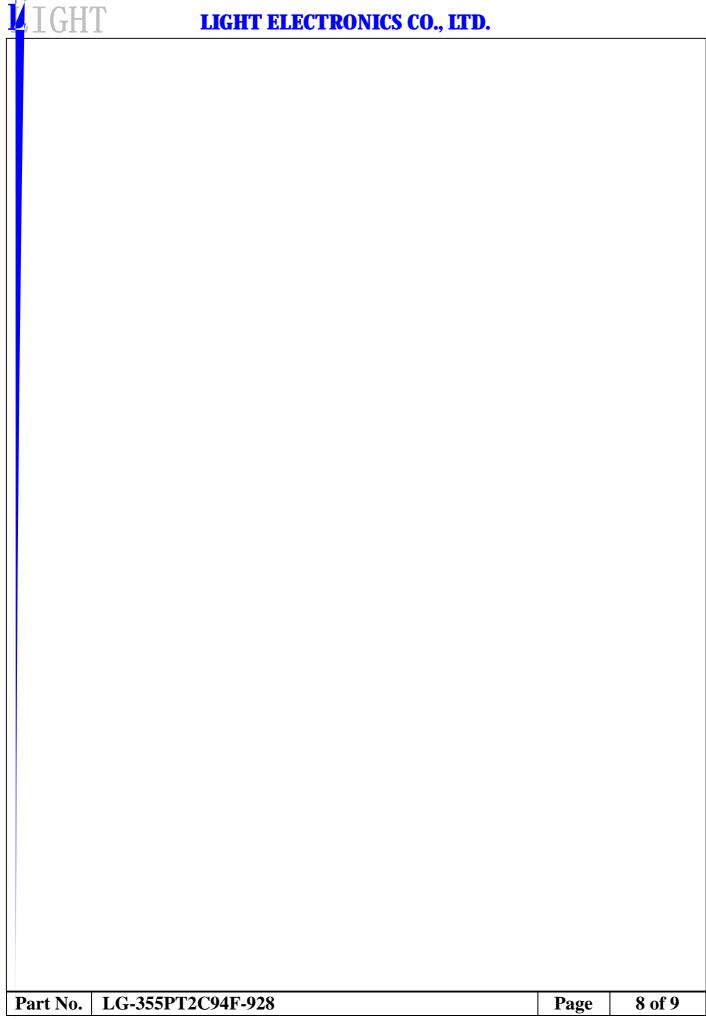
2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).



3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

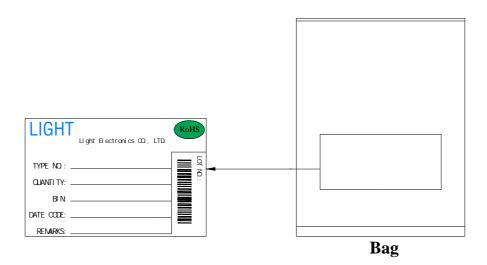


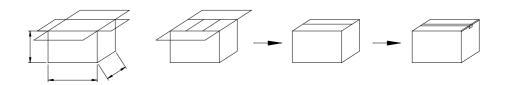
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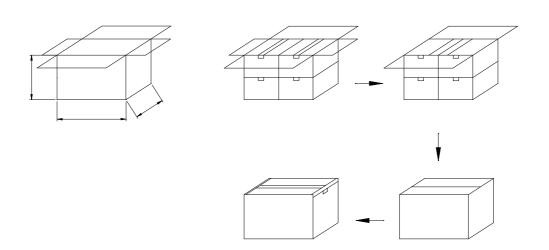




PACKAGE







| Bag minimum volume | Bag volume | Inner box volume | Outer carton volume |
|--------------------|-------------|------------------|---------------------|
| (pcs / Bag) | (pcs / Bag) | (Bag / box) | (Box / Carton) |
| 500 | 1000 | 10 | 4 |

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